



AO4800A

Dual N-Channel Enhancement Mode Field Effect Transistor

General Description

The AO4800A uses advanced trench technology to provide excellent $R_{\rm DS(ON)}$ and low gate charge. The two MOSFETs make a compact and efficient switch and synchronous rectifier combination for use in buck converters. Standard Product AO4800A is Pb-free (meets ROHS & Sony 259 specifications). AO4800AL is a Green Product ordering option. AO4800A and AO4800AL are electrically identical.

Features

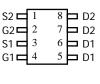
 $V_{DS}(V) = 30V$

 $I_D = 6.9A (V_{GS} = 10V)$

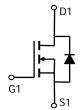
 $R_{DS(ON)}$ < 27m Ω (V_{GS} = 10V)

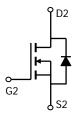
 $R_{DS(ON)}$ < 32m Ω (V_{GS} = 4.5V)

 $R_{DS(ON)}$ < 50m Ω (V_{GS} = 2.5V)









Absolute Maximum Ratings T _A =25°C unless otherwise noted							
Parameter Drain-Source Voltage		Symbol	Maximum	Units			
		V _{DS}	30	V			
Gate-Source Voltage		V_{GS}	±12	V			
Continuous Drain	T _A =25°C		6.9				
Current ^A	T _A =70°C	I _D	5.8	Α			
Pulsed Drain Current B		I _{DM}	40				
	T _A =25°C	В	1.9	10/			
Power Dissipation	T _A =70°C	$-P_{D}$	1.2	W			
Junction and Storage Temperature Range		T _J , T _{STG}	-55 to 150	°C			

Thermal Characteristics									
Parameter	Symbol	Тур	Max	Units					
Maximum Junction-to-Ambient A	t ≤ 10s	$ R_{\theta JA}$	55	62.5	°C/W				
Maximum Junction-to-Ambient A	Steady-State	Т∙⊕ЈА	90	110	°C/W				
Maximum Junction-to-Lead ^C	Steady-State	$R_{ heta JL}$	40	48	°C/W				

Electrical Characteristics (T_J=25°C unless otherwise noted)

Symbol	Parameter	Conditions	Min	Тур	Max	Units
STATIC F	PARAMETERS					
BV_{DSS}	Drain-Source Breakdown Voltage	$I_D = 250 \mu A, V_{GS} = 0 V$	30			V
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} =24V, V _{GS} =0V		0.002	1	μА
		T _J =55°C			5	μΑ
I_{GSS}	Gate-Body leakage current	V_{DS} =0V, V_{GS} = ±12V			100	nA
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS}=V_{GS} I_{D}=250 \mu A$	0.7	1	1.5	V
$I_{D(ON)}$	On state drain current	V_{GS} =4.5V, V_{DS} =5V	40			Α
R _{DS(ON)}	Static Drain-Source On-Resistance	V _{GS} =10V, I _D =6.9A		20	27	mΩ
		T _J =125°C		25	40	11122
		V_{GS} =4.5V, I_D =6A		23	32	mΩ
		V_{GS} =2.5V, I_D =5A		34	50	mΩ
g FS	Forward Transconductance	V_{DS} =5V, I_{D} =5A	10	26		S
V_{SD}	Diode Forward Voltage	I _S =1A,V _{GS} =0V		0.71	1	V
Is	Maximum Body-Diode Continuous Current				4.5	Α
DYNAMIC	PARAMETERS					
C _{iss}	Input Capacitance			900	1100	pF
C _{oss}	Output Capacitance	V_{GS} =0V, V_{DS} =15V, f=1MHz		88		pF
C _{rss}	Reverse Transfer Capacitance			65		pF
R_g	Gate resistance	V _{GS} =0V, V _{DS} =0V, f=1MHz		0.95	1.5	Ω
SWITCHI	NG PARAMETERS					
Q_g	Total Gate Charge			10	12	nC
Q_{gs}	Gate Source Charge	V_{GS} =4.5V, V_{DS} =15V, I_{D} =8.5A		1.8		nC
Q_{gd}	Gate Drain Charge			3.75		nC
t _{D(on)}	Turn-On DelayTime			3.2		ns
t _r	Turn-On Rise Time	V_{GS} =10V, V_{DS} =15V, R_L =1.8 Ω ,		3.5		ns
$t_{D(off)}$	Turn-Off DelayTime	R_{GEN} =6 Ω		21.5		ns
t _f	Turn-Off Fall Time]		2.7		ns
t _{rr}	Body Diode Reverse Recovery Time	I _F =5A, dI/dt=100A/μs		16.8	20	ns
Q_{rr}	Body Diode Reverse Recovery Charge	I _F =5A, dI/dt=100A/μs		8	12	nC

A: The value of $R_{\theta JA}$ is measured with the device mounted on $1in^2$ FR-4 board with 2oz. Copper, in a still air environment with T_A =25°C. The value in any given application depends on the user's specific board design. The current rating is based on the t≤ 10s thermal resistance rating.

Rev 0 : Jan 2006

THIS PRODUCT HAS BEEN DESIGNED AND QUALIFIED FOR THE CONSUMER MARKET. APPLICATIONS OR USES AS CRITICAL COMPONENTS IN LIFE SUPPORT DEVICES OR SYSTEMS ARE NOT AUTHORIZED. AOS DOES NOT ASSUME ANY LIABILITY ARISING OUT OF SUCH APPLICATIONS OR USES OF ITS PRODUCTS. AOS RESERVES THE RIGHT TO IMPROVE PRODUCT DESIGN, FUNCTIONS AND RELIABILITY WITHOUT NOTICE.

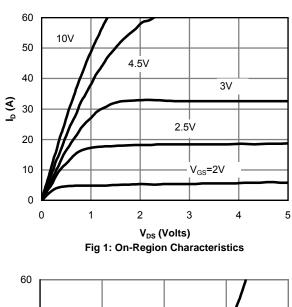
B: Repetitive rating, pulse width limited by junction temperature.

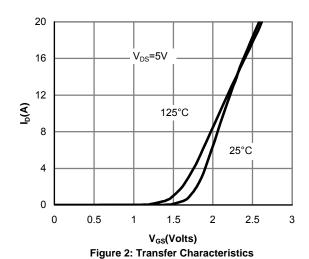
C. The R $_{\theta JA}$ is the sum of the thermal impedence from junction to lead R $_{\theta JL}$ and lead to ambient.

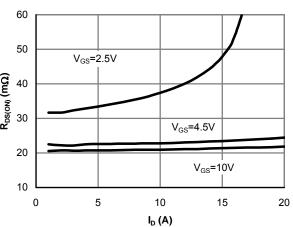
D. The static characteristics in Figures 1 to 6 are obtained using $80\mu s$ pulses, duty cycle 0.5% max.

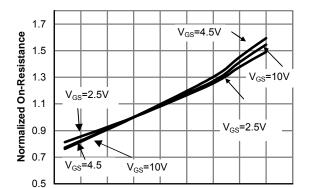
E. These tests are performed with the device mounted on 1 in 2 FR-4 board with 2oz. Copper, in a still air environment with T_A =25 $^{\circ}$ C. The SOA curve provides a single pulse rating.

TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS









50

25

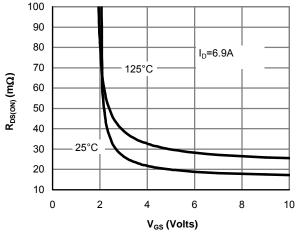
-25

-50

Figure 3: On-Resistance vs. Drain Current and Gate Voltage

Temperature (°C)
Figure 4: On-Resistance vs. Junction
Temperature

75 100 125 150 175



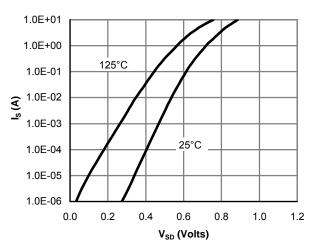


Figure 5: On-Resistance vs. Gate-Source Voltage

TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS

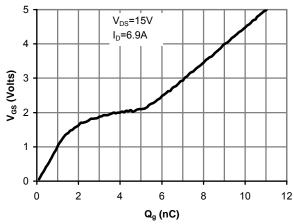


Figure 7: Gate-Charge Characteristics

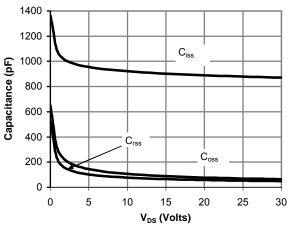


Figure 8: Capacitance Characteristics

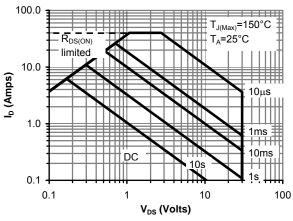


Figure 9: Maximum Forward Biased Safe Operating Area (Note E)

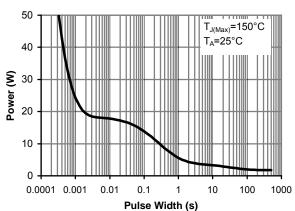


Figure 10: Single Pulse Power Rating Junction-to-Ambient (Note E)

C

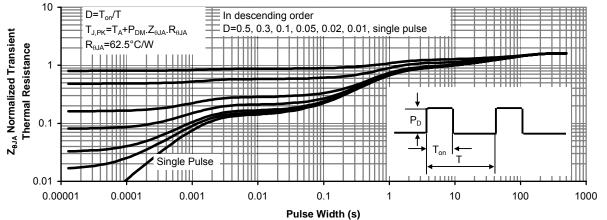


Figure 11: Normalized Maximum Transient Thermal Impedance